

Automotive MOSFET

OptiMOS™-5 Power-Transistor







Features

- OptiMOS[™] power MOSFET for automotive applications
- N-channel Enhancement mode Logic Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested

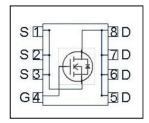


General automotive applications.

Product validation

Qualified for automotive applications. Product validation according to AEC-Q101.





Product Summary

$V_{ m DS}$	60	V
R _{DS(on)}	1.50	mΩ
I _D (chip limited)	230	А

Туре	Package	Marking
IAUC120N06S5N015	PG-TDSON-8-43	5N06N015

IAUC120N06S5N015



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Maximum ratings

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I D	V _{GS} =10 V, Chip limitation ^{1,2)}	230	А
		V _{GS} =10V, DC current ³⁾	120	
		T_a =85 °C, V_{GS} =10 V, R_{thJA} on 2s2p ^{2,4)}	30	
Pulsed drain current ²⁾	/ _{D,pulse}	T _C =25 °C, t _p = 100 μs	757	1
Avalanche energy, single pulse ²⁾	E AS	/ _D =60 A	345	mJ
Avalanche current, single pulse	I _{AS}	-	120	А
Gate source voltage	V _{GS}	-	±20	V
Power dissipation	P _{tot}	Т _С =25 °С	167	W
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	

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Thermal characteristics²⁾

Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	_	0.90	K/W
Thermal resistance, junction - ambient ⁴⁾	R _{thJA}	-	-	23.3	-	

Electrical characteristics

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Symbol Conditions	Values			Unit
			min.	typ.	max.	1
Static characteristics	-		-	-	-	
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} =0 V, / _D =1 mA	60	_	-	V
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 94 \mu A$	2.2	2.8	3.4	
Zero gate voltage drain current	I _{DSS}	$V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	-	_	1	μΑ
		V_{DS} =60 V, V_{GS} =0 V, T_{j} =125 °C ²⁾	-	-	100	
Gate-source leakage current	I _{GSS}	V _{GS} =20 V, V _{DS} =0 V	-	-	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =7 V, I _D =30 A	-	1.60	1.90	mΩ
		V_{GS} =10 V, I_{D} =60 A	-	1.30	1.50	
Gate resistance ²⁾	R _G	-	-	1.6	_	Ω



Parameter	Symbol	Symbol Conditions		Values		
			min.	typ.	max.	
Dynamic characteristics ²⁾	-				-	-
Input capacitance	C iss		-	5348	6952	pF
Output capacitance	C oss	V_{GS} =0 V, V_{DS} =30 V, f =1 MHz	-	1160	1507	
Reverse transfer capacitance	C _{rss}	1	-	56	84	
Turn-on delay time	t _{d(on)}		-	13	_	ns
Rise time	t _r	V_{DD} =30 V, V_{GS} =10 V, I_{D} =60 A, $R_{G,ext}$ =3.5 Ω	-	7	_	
Turn-off delay time	t _{d(off)}		-	27	_	
Fall time	t _f		-	17	_	
Gate to drain charge Gate charge total	Q gs Q gd	V_{DD} =30 V, I_{D} =60 A, V_{GS} =0 to 10 V	-	24 13.7	31 21	nC
Gate charge total	Q _g		-	73.7	96	-
Gate plateau voltage	$V_{\rm plateau}$		-	4.5	_	V
Reverse Diode						
Diode continous forward current ²⁾	I _S	T c=25 °C	-	_	120	А
Diode pulse current ²⁾	/ _{S,pulse}	T _C =25 °C, t _p = 100 μs	ı	-	757	
Diode forward voltage	V _{SD}	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =60 A, $T_{\rm j}$ =25 °C	-	0.8	1.1	V
Reverse recovery time ²⁾	t rr	V _R =30 V, / _F =50A,	-	49	-	ns
Reverse recovery charge ²⁾	Q rr	$di_F/dt = 100 \text{ A/}\mu\text{s}$	-	49	-	nC

¹⁾ Practically the current is limited by the overall system design including the customer-specific PCB.

 $^{^{2)}}$ The parameter is not subject to production testing – specified by design.

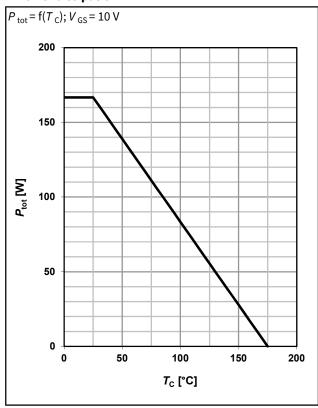
³⁾ Current is limited by package.

⁴⁾ Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

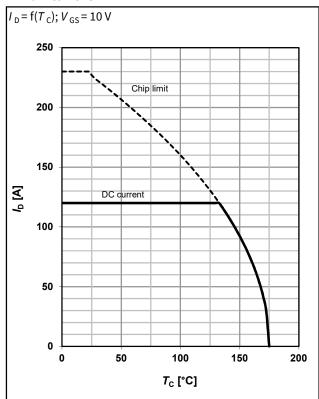


Electrical characteristics diagrams

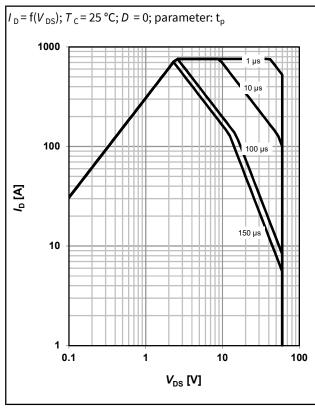
1 Power dissipation



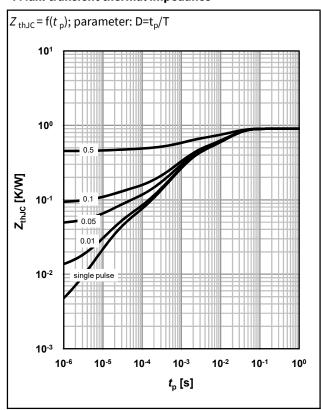
2 Drain current



3 Safe operating area

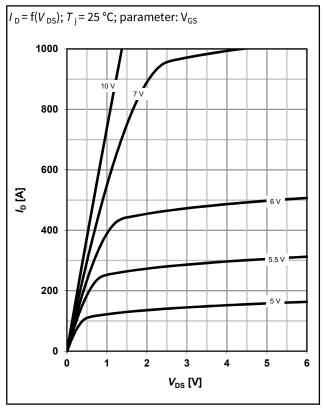


4 Max. transient thermal impedance

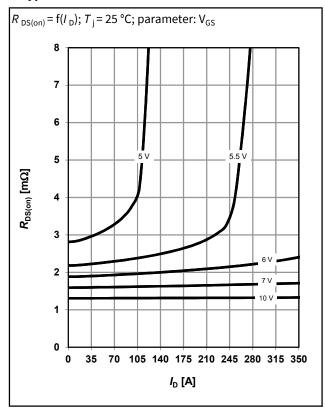




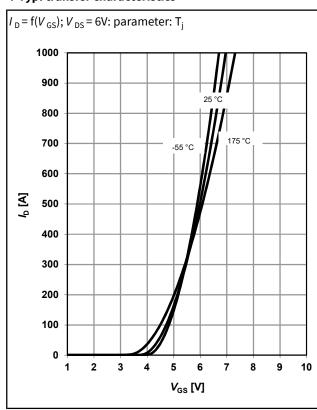
5 Typ. output characteristics



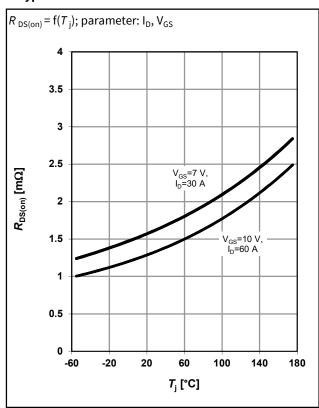
6 Typ. drain-source on-state resistance



7 Typ. transfer characteristics



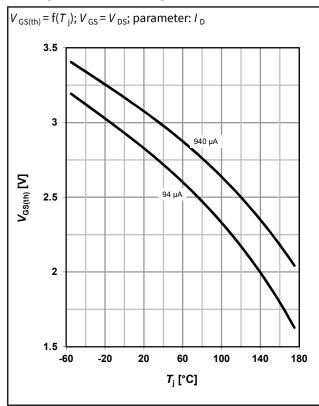
8 Typ. drain-source on-state resistance



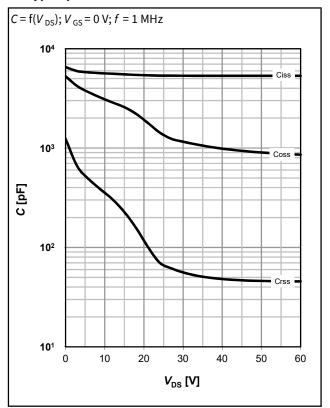
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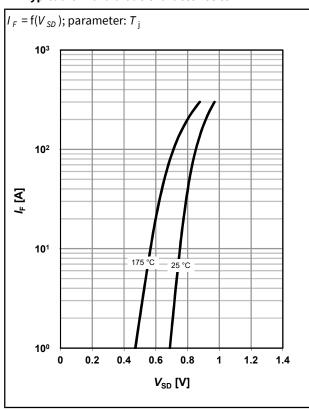
9 Typ. gate threshold voltage



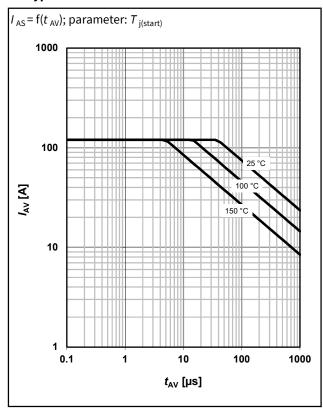
10 Typ. capacitances



11 Typical forward diode characteristics

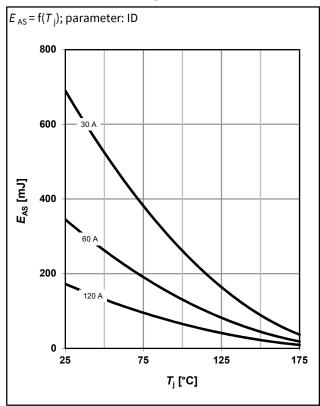


12 Typ. avalanche characteristics

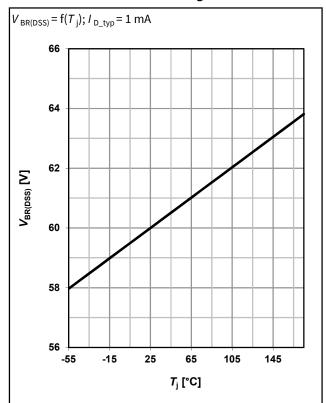


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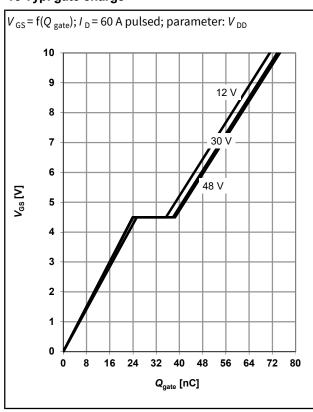
13 Typical avalanche energy



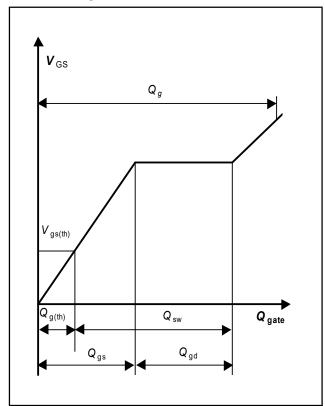
14 Drain-source breakdown voltage



15 Typ. gate charge



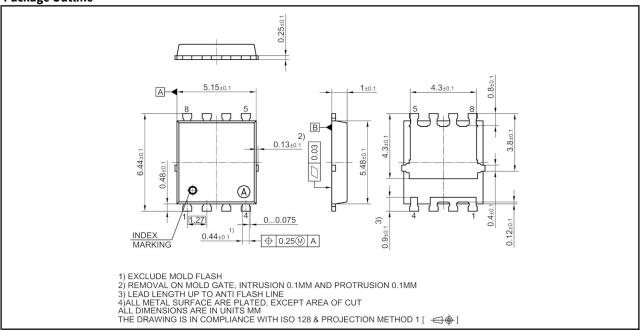
16 Gate charge waveforms



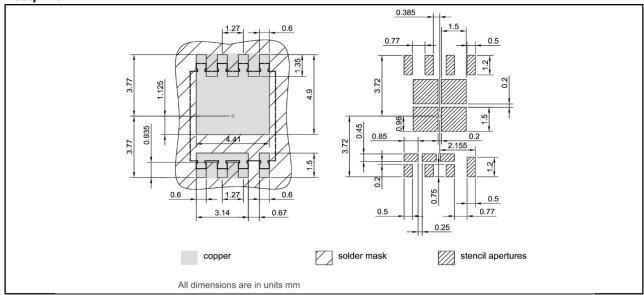
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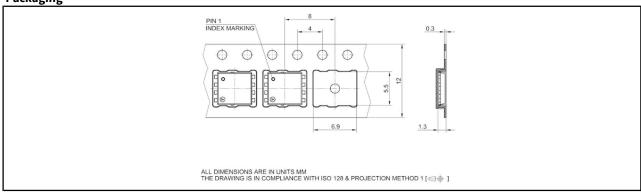
Package Outline



Footprint







IAUC120N06S5N015



Revision History

Revision	Date	Changes
Revision 1.0	2024-04-11	Final Data Sheet

Trademarks

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Email: erratum@infineon.com

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